**Product data sheet** 

## 1 Product profile

### 1.1 General description

General-purpose PIN diode in an SOD323 small plastic SMD package.

#### 1.2 Features and benefits

- · Low diode capacitance
- · Low diode forward resistance

### 1.3 Applications

General RF application



**General purpose PIN diode** 

## 2 Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode		1.4
2	anode	1 2	<b>-</b> ₩-
		Top view	

## 3 Ordering information

**Table 2. Ordering information** 

Type number	Package		
	Name	Description	Version
BAP50-03	SC-76	plastic surface-mounted package; 2 leads	SOD323

## 4 Marking

Table 3. Marking code

Type number	Marking code
BAP50-03	A8 <sup>[1]</sup>

<sup>[1]</sup> The marking bar indicates the cathode (see  $\underline{\text{Table 1}}$ ).

## 5 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	50	V
I <sub>F</sub>	forward current		-	50	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> ≤ 90 °C	-	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

### 6 Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Тур	Unit
ui(j-3p)	thermal resistance from junction to solder point		85	K/W

General purpose PIN diode

### 7 Characteristics

### **Table 6. Characteristics**

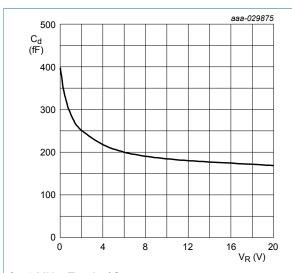
 $T_i$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA		-	0.95	1.1	V
V <sub>R</sub>	reverse voltage	I <sub>R</sub> = 10 μA		50	-	-	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 50 V		-	-	100	nA
C <sub>d</sub>	diode capacitance	f = 1 MHz (see Figure 1)	,				
		V <sub>R</sub> = 0 V		-	0.4	-	pF
		V <sub>R</sub> = 1 V		-	0.3	0.55	pF
		V <sub>R</sub> = 5 V		-	0.2	0.35	pF
r <sub>D</sub>	diode forward resistance	f = 100 MHz (see Figure 2)					
		I <sub>F</sub> = 0.5 mA	[1]	-	25	40	Ω
		I <sub>F</sub> = 1 mA	[1]	-	14	25	Ω
		I <sub>F</sub> = 10 mA	[1]	-	3	5	Ω

<sup>[1]</sup> Guaranteed on AQL basis: inspection level S4, AQL 1.0.

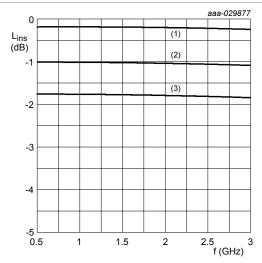
### General purpose PIN diode

## 8 Graphical data



f = 1 MHz;  $T_i = 25 °C$ .

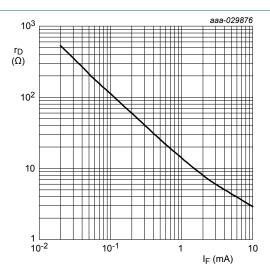
Figure 1. Diode capacitance as a function of reverse voltage (typical values)



Diode inserted in series with a 50  $\Omega$  strip line circuit and biased via the analyzer T-network. T<sub>amb</sub> = 25  $^{\circ}C.$ 

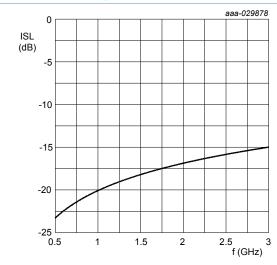
- (1)  $I_F = 10 \text{ mA}$
- (2)  $I_F = 1 \text{ mA}$
- (3)  $I_F = 0.5 \text{ mA}$

Figure 3. Insertion loss of the diode as a function of frequency (typical values)



 $f = 100 \text{ MHz}; T_i = 25 ^{\circ}\text{C}.$ 

Figure 2. Diode forward resistance as a function of forward current (typical values)



Diode zero biased and inserted in series with a 50  $\Omega$  strip line circuit.  $T_{amb}$  = 25  $^{\circ}C.$ 

Figure 4. Isolation of the diode as a function of frequency (typical values)

**General purpose PIN diode** 

## 9 Package outline

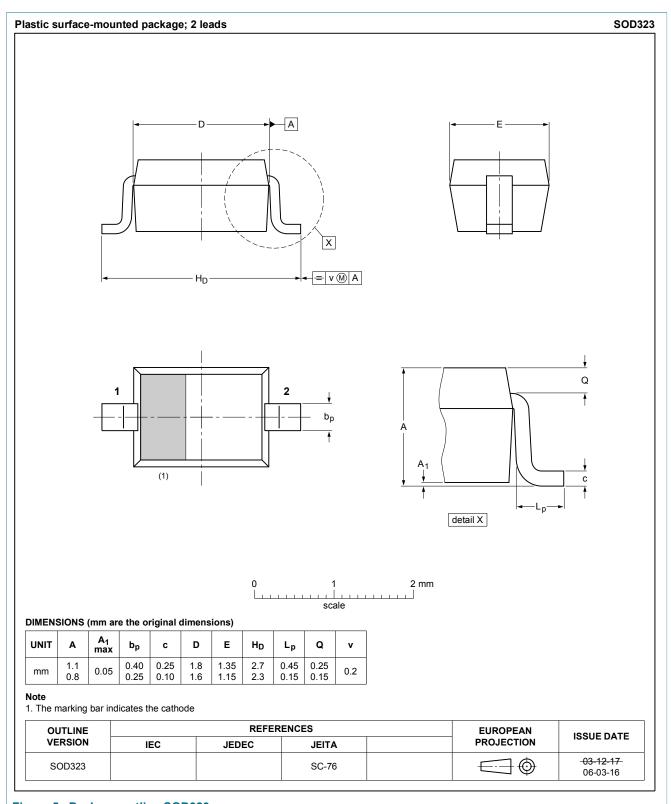


Figure 5. Package outline SOD323

General purpose PIN diode

### 10 Abbreviations

#### Table 7. Abbreviations

Acronym	Description
AQL	acceptable quality level
PIN	P-type, intrinsic, N-type
RF	radio frequency
S4	special inspection level 4
SMD	surface-mounted device

# 11 Revision history

### Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP50-03 v.5	20182611	Product data sheet	-	BAP50-03 v.4
Modifications:		eatures and benefits" has beer ormation" pages have been up	•	
BAP50-03 v.4	20090911	Product data sheet	-	BAP50-03 v.3
BAP50-03 v.3	20040211	Product data sheet	-	BAP50-03 v.2
BAP50-03 v.2	19990510	Product data sheet	-	BAP50-03 v.1
BAP50-03 v.1	19990201	Preliminary data sheet	-	-

General purpose PIN diode

### 12 Legal information

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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#### General purpose PIN diode

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